ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES International and Pan-4	. Bannockł	burn, Illinois, A	ll rights reserved nations.	under both	This docume level parts, t	ent is a declarati the declaration e	on of the su	ibstances s all lower	within the manufactu level materials for w	rer listed	item. Note: nanufactur	if the item is an as rer has engineering	sembly with lower responsibility.	
IPC Web Site for Infor	IPC Web Site for Information on IPC 1752 Standard				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				ials and N	als and Mfg Information				
Supplier Information														
Company name*	Company uni	Company unique ID			Unique ID Authority					Response Date*				
onsemi										2024-05	2024-05-21			
Contact Name Title - Contact			:t			Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title -			tle - Representative			Phone - Representative*				Email -	Email - Representative*			
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	NVMFD 1G	NVMFD5485NLWFT NFET DFN8 60		20A 60MOHM		2024-05-21		N	MY1		89.49	mg	Each	
Manufacturing Proccess Information	n													
Terminal Plating / Grid Array Mate	rial 7	Terminal Base Alloy		J-STD-020 MSL	Rating	Peak Proce	rocess Body Temperature Max Time at Peak		Tempera	ture Nun	nber of Reflow Cyc	cles		
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		<b>260</b> C		С	<b>30</b> se		seconds 3			
Comments														
level 1 - maximum time at peak temperature	during so	ldering is 10-3	0 seconds											
For more information regarding material co	mposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	0.34	mg	Supplier	Zinc (Zn)	7440-66-6		0.0004	mg
			Supplier	Iron (Fe)	7439-89-6		0.008	mg
			Supplier	Copper (Cu)	7440-50-8		0.3315	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0001	mg
Die	0.36	mg	Supplier	Silicon (Si)	7440-21-3		0.36	mg
Die Attach Solder	0.82	mg	Supplier	Silver (Ag)	7440-22-4		0.0205	mg
			А	Lead (Pb)	7439-92-1	7a	0.7585	mg
			Supplier	Tin (Sn)	7440-31-5		0.041	mg
Lead Frame	37.39	mg	Supplier	Silver (Ag)	7440-22-4		0.3739	mg
			Supplier	Iron (Fe)	7439-89-6		0.0374	mg
			Supplier	Copper (Cu)	7440-50-8		36.9675	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0112	mg
Mold Compound-Black	48.93	mg		Epoxy resin	proprietary data		3.6698	mg
			Supplier	Phenolic Resin	Proprietary Data		1.2233	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3.6698	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2446	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.1226	mg
Plating	1.56	mg	Supplier	Tin (Sn)	7440-31-5		1.56	mg
Wire Bond - Cu	0.09	mg	Supplier	Copper (Cu)	7440-50-8		0.09	mg